

THERMALLY CONDUCTIVE

CHARACTERISTICS					HANDLING PROPERTIES			TYPICAL CURED PROPERTIES							
Product	Chemistry	Chemical Resistance	Low Viscosity	High Temp.	Mixed Viscosity (cP@25°C)	Mix Ratio by Weight	Cure Temp. Room/Heat	Temperature Range of Use	Specific Gravity	Hardness	Thermal Conductivity (W/m.K)	Dielectric Strength (V/mil)	Dielectric Constant at 1mHz	Features and Typical Applications	
THERMALLY CONDUCTIVE															
One Component Systems															
2851FT	Epoxy	Excellent		X	100,000	N/A	Heat	-55 to +155°C	2.25	94D	1.44	N/A	5.2	Provide excellent heat dissipation and thermal shock resistance as well as protection from moisture and chemical agents. Typical applications include sensors, which operate in harsh environments, transformers, transducers, switches, and other small devices.	
906-1	Epoxy	Excellent		X	190,000	N/A	Heat	-40 to +180°C	2.30	90D	0.86	400	N/A		
Two Component Systems															
1495/11	Epoxy	Good		X	14,000	100:5	Heat	-55 to +155°C	1.89	95D	1.25	400	4.1		
2850FT/11	Epoxy	Excellent		X	64,000	100:4.5	Heat	-55 to +155°C	2.29	96D	1.28	380	5.4		
4954/25	Silicone	Poor		X	40,000	100:0.4	RT/HT	-65 to +260°C	2.30	80A	1.30	520	5.0		

CHARACTERISTICS					HANDLING PROPERTIES			TYPICAL CURED PROPERTIES								
Product	Chemistry	Thermally Conductive	Chemical Resistance	Low Viscosity	High Temp.	Mixed Viscosity (cP@25°C)	Mix Ratio by Weight	Cure Temp. Room/Heat	Temperature Range of Use	Specific Gravity	Hardness	Thermal Conductivity (W/m.K)	Dielectric Strength (V/mil)	Dielectric Constant at 1mHz	Features and Typical Applications	
GENERAL PURPOSE																
One Component Systems																
A-312	Epoxy		Excellent	X		3,000	N/A	Heat	-40 to +130°C	1.14	86D	N/A	N/A	N/A	These general purpose encapsulants were designed to offer a wide range of features including thermal conductivity, mechanical shock and impact resistance, as well as thermal shock protection.	
E-151-8	Epoxy		Good	X		1,100	N/A	Heat	-40 to +130°C	1.05	55D	N/A	325	3.4(3)		
Two Component Systems																
1090/11	Epoxy		Good		X	29,000	100:10.5	Heat	-55 to +155°C	0.80	82D	0.19	375	2.7		
2057/9	Epoxy		Good	X		4,000	100:6.5	RT/HT	-40 to +130°C	1.54	85D	N/A	400	4.2		
2651-40/23LV	Epoxy	X	Good	X		2,200	100:18	RT/HT	-65 to +105°C	1.40	85D	0.55	450	3.8		
2651MM/11	Epoxy	X	Good		X	13,000	100:8.5	Heat	-55 to +155°C	1.59	89D	0.60	450	3.7		
E-1400 A/B	Epoxy	X	Good			15,000	100:100	RT/HT	-65 to +105°C	1.68	75D	0.74	400	4.0		

Please call us at **1-800-832-4929** to talk to our application experts, order a free evaluation sample, or receive more information about our products.

(1) Dielectric constant measured at 60Hz (2) Dielectric constant measured at 1kHz (3) Dielectric constant measured at 100Hz

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EASY MIX RATIO

CHARACTERISTICS						HANDLING PROPERTIES			TYPICAL CURED PROPERTIES						
Product	Chemistry	Thermally Conductive	Chemical Resistance	Low Viscosity	High Temp.	Mixed Viscosity (cP@25°C)	Mix Ratio by Weight	Cure Temp. Room/Heat	Temperature Range of Use	Specific Gravity	Hardness	Thermal Conductivity (W/m.K)	Dielectric Strength (V/mil)	Dielectric Constant at 1mHz	Features and Typical Applications
EASY MIX RATIO															
1265 A/B	Epoxy		Good	X		600	100:100	Heat	-40 to +65°C	1.08	25A	N/A	N/A	3.0	Primarily designed for ease of use in either meter mix or manual dispense operations. These products also offer a wide range of features including heat dissipation, thermal and mechanical shock, as well as thermal conductivity.
1269A A/B	Epoxy		Good	X	X	5,000	100:100	Heat	-40 to +130°C	1.20	85D	0.27	430	3.8	
1497 A/B	Epoxy	X	Good		X	150,000	100:100	Heat	-65 to +155°C	1.70	80D	0.68	425	3.6	
2072 A/B	Epoxy		Good	X	X	8,000	100:50	RT/HT	-40 to +130°C	1.60	89D	0.42	400	4.2	
2741LV/15LV	Epoxy		Good			30,000	400:100	RT/HT	-40 to +90°C	1.43	80D	N/A	400	3.3	
2760 A/B	Epoxy/ Polyurethane	X	Good			18,000	100:50	RT/HT	-40 to +130°C	1.55	80D	0.60	450	4.0	
3180M A/B	Epoxy		Good			15,000	100:100	RT/HT	-40 to +130°C	1.62	80D	0.40	430	4.0	
5952 A/B	Silicon	X	Poor		X	40,000	100:100	RT/HT	-65 to +260°C	2.05	75A	0.85	450	5.0	
E-1410 A/B	Epoxy	X	Good		X	35,000	100:100	Heat	-40 to +175°C	1.80	94D	0.57	N/A	4.0(3)	
S 5225 A/B	Silicone		Poor	X	X	2,420	100:100	RT/HT	-60 to +220°C	1.59	53A	N/A	450	3.0	
GENERAL PURPOSE															
One Component Systems															
A-312	Epoxy		Excellent	X		3,000	N/A	Heat	-40 to +130°C	1.14	86D	N/A	N/A	N/A	These general purpose encapsulants were designed to offer a wide range of features including thermal conductivity, mechanical shock and impact resistance, as well as thermal shock protection.
E-151-8	Epoxy		Good	X		1,100	N/A	Heat	-40 to +130°C	1.05	55D	N/A	325	3.4(3)	
Two Component Systems															
1090/11	Epoxy		Good		X	29,000	100:10.5	Heat	-55 to +155°C	0.80	82D	0.19	375	2.7	These general purpose encapsulants were designed to offer a wide range of features including thermal conductivity, mechanical shock and impact resistance, as well as thermal shock protection.
2057/9	Epoxy		Good	X		4,000	100:6.5	RT/HT	-40 to +130°C	1.54	85D	N/A	400	4.2	
2651-40/23LV	Epoxy	X	Good	X		2,200	100:18	RT/HT	-65 to +105°C	1.40	85D	0.55	450	3.8	
2651MM/11	Epoxy	X	Good		X	13,000	100:8.5	Heat	-55 to +155°C	1.59	89D	0.60	450	3.7	
E-1400 A/B	Epoxy	X	Good			15,000	100:100	RT/HT	-65 to +105°C	1.68	75D	0.74	400	4.0	

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(1) Dielectric constant measured at 60Hz (2) Dielectric constant measured at 1kHz (3) Dielectric constant measured at 100Hz

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FLAME RETARDANT

CHARACTERISTICS						HANDLING PROPERTIES			TYPICAL CURED PROPERTIES							
Product	Chemistry	Thermally Conductive	Chemical Resistance	Low Viscosity	High Temp.	Mixed Viscosity (cP@25°C)	Mix Ratio by Weight	Cure Temp. Room/Heat	Temperature Range of Use	Specific Gravity	Hardness	Thermal Conductivity (W/m.K)	Dielectric Strength (V/mil)	Dielectric Constant at 1mHz	Features and Typical Applications	
FLAME RETARDANT																
One Component Systems																
G-508-1	Epoxy	X	Good		X	20,000	N/A	Heat	-20 to +180°C	1.55	85D	0.60	N/A	N/A	Provide flame resistance down to 1/8 of an inch. These products also offer various other features such as thermal shock protection, low viscosity, and thermal conductivity. Typical applications include a wide range of electrical components such as capacitors and transformers.	
E-1320FR	Epoxy		Good			23,600	N/A	Heat	-40 to +130°C	1.59	80D	N/A	N/A	N/A		
Two Component Systems																
2057FR/11	Epoxy		Good	X	X	3,400	100:8	Heat	-55 to +155°C	1.58	85D	0.40	425	4.4		
2651-40FR/9	Epoxy	X	Good	X		8,000	100:9	RT/HT	-40 to +130°C	1.49	87D	0.55	450	3.8		
2850FT-FR/11	Epoxy	X	Excellent		X	65,000	100:4	RT/HT	-55 to +155°C	2.33	94D	1.23	490	6.0		
E-1420FR A/B	Epoxy		Good	X		5,000	100:100	RT/HT	-40 to +130°C	1.27	65D	N/A	N/A	2.7		
XT-5038-9 A/B	Epoxy		Good	X		1,600	100:11	RT/HT	-40 to +130°C	1.48	85D	N/A	N/A	4.0		
GENERAL PURPOSE																
One Component Systems																
A-312	Epoxy		Excellent	X		3,000	N/A	Heat	-40 to +130°C	1.14	86D	N/A	N/A	N/A	These general purpose encapsulants were designed to offer a wide range of features including thermal conductivity, mechanical shock and impact resistance, as well as thermal shock protection.	
E-151-8	Epoxy		Good	X		1,100	N/A	Heat	-40 to +130°C	1.05	55D	N/A	325	3.4(3)		
Two Component Systems																
1090/11	Epoxy		Good		X	29,000	100:10.5	Heat	-55 to +155°C	0.80	82D	0.19	375	2.7		
2057/9	Epoxy		Good	X		4,000	100:6.5	RT/HT	-40 to +130°C	1.54	85D	N/A	400	4.2		
2651-40/23LV	Epoxy	X	Good	X		2,200	100:18	RT/HT	-65 to +105°C	1.40	85D	0.55	450	3.8		
2651MM/11	Epoxy	X	Good		X	13,000	100:8.5	Heat	-55 to +155°C	1.59	89D	0.60	450	3.7		
E-1400 A/B	Epoxy	X	Good			15,000	100:100	RT/HT	-65 to +105°C	1.68	75D	0.74	400	4.0		

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CHARACTERISTICS						HANDLING PROPERTIES			TYPICAL CURED PROPERTIES						Features and Typical Applications	
Product	Chemistry	Thermally Conductive	Chemical Resistance	Low Viscosity	High Temp.	Mixed Viscosity (cP@25°C)	Mix Ratio by Weight	Cure Temp. Room/Heat	Temperature Range of Use	Specific Gravity	Hardness	Thermal Conductivity (W/m.K)	Dielectric Strength (V/mil)	Dielectric Constant at 1mHz		
FLEXIBLE																
One Component Systems																
E-151-8	Epoxy		Good	X		1,100	N/A	Heat	-40 to +130°C	1.05	55D	N/A	325	3.4(2)	Protection of stress sensitive components where shock and impact resistance are required. Typical applications include transformers, motors, coils and other electrical devices.	
Two Component Systems																
1365-25 A/B	Epoxy		Good	X		150	100:100	RT/HT	-55 to +90°C	1.01	25A	N/A	N/A	4.0(1)		
1365-65 A/B	Epoxy		Good	X		345	100:100	RT/HT	-55 to +90°C	1.03	65A	N/A	N/A	4.0(1)		
2741/15	Epoxy		Good			36,000	100:150	RT/HT	-55 to +65°C	1.15	60A	0.35	350	3.3		
2754 A/B	Epoxy	X	Good			24,000	100:40	RT/HT	-65 to +10°C	1.53	80A	0.63	450	4.9		
S 5225 A/B	Silicone		Poor	X	X	2,420	100:100	RT/HT	-60 to +220°C	1.59	53A	N/A	450	3.0		
TU-906 A/B	Polyurethane		Good	X		3,100	100:400	RT/HT	-40 to +13°C	1.00	50A	N/A	N/A	N/A		
XT-1122 A/B	Epoxy		Good	X	X	1,000	100:66.7	Heat	-55 to +155°C	1.05	45D	0.29	360	3.2(2)		
LOW STRESS																
Two Component Systems																
2754 A/B	Epoxy	X	Good			24,000	100:40	RT/HT	-65 to +105°C	1.53	80A	0.63	450	4.9	Designed for the encapsulation of a wide range of stress sensitive electronics. Provides excellent performance at low temperatures and protection from mechanical shock and vibration.	
E-1000 A/B	Epoxy		Good	X		1,500	100:120	Heat	-40 to +65°C	1.05	30A	N/A	300	4.9(3)		
E-1030 A/B	Epoxy	X	Good			12,000	100:14	Heat	-55 to +105°C	1.93	79A	0.58	375	5.8		
GENERAL PURPOSE																
One Component Systems																
A-312	Epoxy		Excellent	X		3,000	N/A	Heat	-40 to +130°C	1.14	86D	N/A	N/A	N/A	These general purpose encapsulants were designed to offer a wide range of features including thermal conductivity, mechanical shock and impact resistance, as well as thermal shock protection.	
E-151-8	Epoxy		Good	X		1,100	N/A	Heat	-40 to +130°C	1.05	55D	N/A	325	3.4(3)		
Two Component Systems																
1090/11	Epoxy		Good		X	29,000	100:10.5	Heat	-55 to +155°C	0.80	82D	0.19	375	2.7		
2057/9	Epoxy		Good	X		4,000	100:6.5	RT/HT	-40 to +130°C	1.54	85D	N/A	400	4.2		
2651-40/23LV	Epoxy	X	Good	X		2,200	100:18	RT/HT	-65 to +105°C	1.40	85D	0.55	450	3.8		
2651MM/11	Epoxy	X	Good		X	13,000	100:8.5	Heat	-55 to +155°C	1.59	89D	0.60	450	3.7		
E-1400 A/B	Epoxy	X	Good			15,000	100:100	RT/HT	-65 to +105°C	1.68	75D	0.74	400	4.0		

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CHARACTERISTICS					HANDLING PROPERTIES			TYPICAL CURED PROPERTIES						Features and Typical Applications	
Product	Chemistry	Thermally Conductive	Chemical Resistance	Low Viscosity	Mixed Viscosity (cP@25°C)	Mix Ratio by Weight	Cure Temp. Room/Heat	Temperature Range of Use	Specific Gravity	Hardness	Thermal Conductivity (W/m.K)	Dielectric Strength (V/mil)	Dielectric Constant at 1mHz		
HIGH SERVICE TEMPERATURE															
One Component Systems															
2651-1	Epoxy	X	Good		52,000	N/A	Heat	-40 to +155°C	1.60	88D	0.58	440	3.7	Ability to withstand high temperatures, thermal shock, and chemical exposure. These products are designed for heat generating electronic devices which operate in harsh environments. Typical applications include sensors, transformers, power supplies, and rectifiers.	
906-1	Epoxy	X	Good		190,000	N/A	Heat	-40 to +180°C	2.30	90D	0.86	400	N/A		
926-82-1	Epoxy		Excellent		130,000	N/A	Heat	-40 to +180°C	1.53	85D	N/A	350	N/A		
933-48	Epoxy		Excellent		150,000	N/A	Heat.	-40 to +180°C	1.45	85D	N/A	350	N/A		
Two Component Systems															
2762/17M-1	Epoxy	X	Excellent		50,000	100:10	Heat	-20 to +230°C	2.26	96D	1.37	400	3.3		
4952/25	Silicone	X	Poor		35,000	100:0.4	RT/HT	-65 to +260°C	2.20	70A	1.00	550	5.2		
5954 A/B	Silicone	X	Poor		35,000	100:100	RT/HT	-65 to +260°C	2.45	85A	1.15	450	5.0		
W-66/17M-1	Epoxy		Excellent		15,000	100:40	Heat	-20 to +220°C	1.23	85D	N/A	510	4.4(3)		
XT-1169 A/B	Epoxy		Good	X	7,300	100:80	Heat	-40 to +155°C	1.44	80D	0.40	420	3.6(3)		

CHARACTERISTICS					HANDLING PROPERTIES			TYPICAL CURED PROPERTIES						Features and Typical Applications	
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GENERAL PURPOSE															
One Component Systems															
A-312	Epoxy		Excellent	X		3,000	N/A	Heat	-40 to +130°C	1.14	86D	N/A	N/A	N/A	These general purpose encapsulants were designed to offer a wide range of features including thermal conductivity, mechanical shock and impact resistance, as well as thermal shock protection.
E-151-8	Epoxy		Good	X		1,100	N/A	Heat	-40 to +130°C	1.05	55D	N/A	325	3.4(3)	
Two Component Systems															
1090/11	Epoxy		Good		X	29,000	100:10.5	Heat	-55 to +155°C	0.80	82D	0.19	375	2.7	
2057/9	Epoxy		Good	X		4,000	100:6.5	RT/HT	-40 to +130°C	1.54	85D	N/A	400	4.2	
2651-40/23LV	Epoxy	X	Good	X		2,200	100:18	RT/HT	-65 to +105°C	1.40	85D	0.55	450	3.8	
2651MM/11	Epoxy	X	Good		X	13,000	100:8.5	Heat	-55 to +155°C	1.59	89D	0.60	450	3.7	
E-1400 A/B	Epoxy	X	Good			15,000	100:100	RT/HT	-65 to +105°C	1.68	75D	0.74	400	4.0	

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■ **Europe**
Nijverheidsstraat 7
B-2260 Westerlo
Belgium
☎ + (32) (0) 14 57 56 11
Fax: + (32) (0) 14 58 55 30

■ **North America**
46 Manning Road
Billerica, MA 01821
☎ (800) 832-4929
☎ (978) 436-9700
Fax: (978) 436-9701

■ **Asia-Pacific**
100 Kaneda, Atsugi-shi
Kanagawa-ken, 243
Japan
☎ (81) 462-25-8815
Fax: (81) 462-22-1347

The information given and the recommendations made herein are based on our research and are believed to be accurate but no guarantee of their accuracy is made. In every case we urge and recommend that purchasers before using any product in full scale production make their own tests to determine to their own satisfaction whether the product is of acceptable quality and is suitable for their particular purposes under their own operating conditions. No representative of ours has any authority to waive or change the foregoing provisions but, subject to such provisions, our engineers are available to assist purchasers in adapting our products to their needs and to the circumstances prevailing in their business. Nothing contained herein shall be construed to imply the nonexistence of any relevant patents or to constitute a permission, inducement or recommendation to practice any invention covered by any patent, without the authority from the owner of this patent. We also expect purchasers to use our products in accordance with the guiding principles of the Chemical Manufacturers Association's Responsible Care® program.